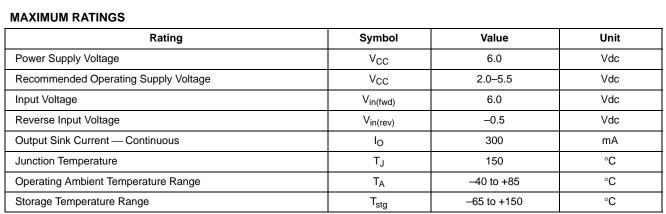
# Advance Information Integrated Relay/Solenoid Driver

- Optimized to Switch 3 V to 5 V Relays from a 5 V Rail
- Compatible with "TX" and "TQ" Series Telecom Relays Rated up to 625 mW at 3 V to 5 V
- Features Low Input Drive Current
- Internal Zener Clamp Routes Induced Current to Ground Rather Than Back to Supply
- Guaranteed Off State with No Input Connection
- Supports Large Systems with Minimal Off–State Leakage
- ESD Resistant in Accordance with the 2000 V Human Body Model
- Provides a Robust Driver Interface Between Relay Coil and Sensitive Logic Circuits

### Applications include:

- Telecom Line Cards and Telephony
- Industrial Controls
- Security Systems
- Appliances and White Goods
- Automated Test Equipment
- Automotive Controls

This device is intended to replace an array of three to six discrete components with an integrated part. It can be used to switch other 3 to 5 Vdc Inductive Loads such as solenoids and small DC motors.



## THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Total Device Dissipation <sup>(1)</sup> Derate above 25°C	PD	P <sub>D</sub> 625	
Thermal Resistance Junction to Ambient	$R_{ hetaJA}$	200	°C/W

1. FR–5 PCB of 1" x 0.75" x 0.062",  $T_A = 25^{\circ}C$ 

This document contains information on a new product. Specifications and information herein are subject to change without notice.

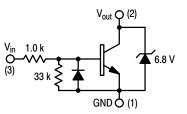
**MDC3205** 

RELAY/SOLENOID DRIVER SILICON MONOLITHIC CIRCUIT BLOCK



CASE 29–11, STYLE 14 TO–92

#### INTERNAL CIRCUIT DIAGRAM





## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Output Zener Breakdown Voltage (@ IT = 10 mA Pulse)	V <sub>(BRout)</sub> V <sub>(-BRout)</sub>	6.4 —	6.8 0.7	7.2	V
Output Leakage Current @ 0 Input Voltage ( $V_{out} = 5.5 \text{ Vdc}, V_{in} = O.C., T_A = 25^{\circ}C$ ) ( $V_{out} = 5.5 \text{ Vdc}, V_{in} = O.C., T_A = 85^{\circ}C$ )	I <sub>OO</sub>	_	_	5.0 30	μΑ
ON CHARACTERISTICS					
Input Bias Current @ $V_{in} = 4.0 \text{ Vdc}$ (I <sub>O</sub> = 250 mA, V <sub>out</sub> = 0.4 Vdc, T <sub>A</sub> = -40°C) (correlated to a measurement @ 25°C)	l <sub>in</sub>	_	2.5	_	mAdc
Output Saturation Voltage ( $I_O = 250 \text{ mA}$ , $V_{in} = 4.0 \text{ Vdc}$ , $T_A = -40^{\circ}\text{C}$ ) (correlated to a measurement @ 25°C)		_	0.2	0.4	Vdc
Output Sink Current — Continuous $(T_A = -40^{\circ}C, V_{CE} = 0.4 \text{ Vdc}, V_{in} = 4.0 \text{ Vdc})$ (correlated to a measurement @ 25°C)	I <sub>C(on)</sub>	250	_	_	mA

## TYPICAL APPLICATION-DEPENDENT SWITCHING PERFORMANCE

### SWITCHING CHARACTERISTICS

Characteristic	Symbol	V <sub>CC</sub>	Min	Тур	Max	Units
Propagation Delay Times:						ns
High to Low Propagation Delay; Figures 1, 2 (5.0 V 74HC04)	t <sub>PHL</sub>	5.5	_	55	—	
Low to High Propagation Delay; Figures 1, 2 (5.0 V 74HC04)	t <sub>PLH</sub>	5.5	—	430	—	
High to Low Propagation Delay; Figures 1, 3 (3.0 V 74HC04)	t <sub>PHL</sub>	5.5	_	85	_	
Low to High Propagation Delay; Figures 1, 3 (3.0 V 74HC04)	t <sub>PLH</sub>	5.5	—	315	—	
High to Low Propagation Delay; Figures 1, 4 (5.0 V 74LS04)	t <sub>PHL</sub>	5.5	_	55	_	
Low to High Propagation Delay; Figures 1, 4 (5.0 V 74LS04)	t <sub>PLH</sub>	5.5	—	2385	—	
Transition Times:						ns
Fall Time; Figures 1, 2 (5.0 V 74HC04)	t <sub>f</sub>	5.5	_	45	_	
Rise Time; Figures 1, 2 (5.0 V 74HC04)	t <sub>r</sub>	5.5	-	160	—	
Fall Time; Figures 1, 3 (3.0 V 74HC04)	t <sub>f</sub>	5.5	_	70	_	
Rise Time; Figures 1, 3 (3.0 V 74HC04)	t <sub>r</sub>	5.5	—	195	—	
Fall Time; Figures 1, 4 (5.0 V 74LS04)	t <sub>f</sub>	5.5	_	45	_	
Rise Time; Figures 1, 4 (5.0 V 74LS04)	t <sub>r</sub>	5.5	—	2400	—	
Input Slew Rate <sup>(1)</sup>	$\Delta V/\Delta t$ in	5.5	TBD	_	_	V/ms

1. Minimum input slew rate must be followed to avoid overdissipating the device.

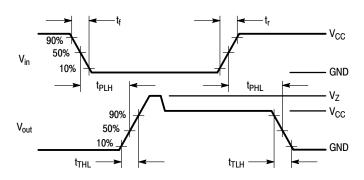


Figure 1. Switching Waveforms

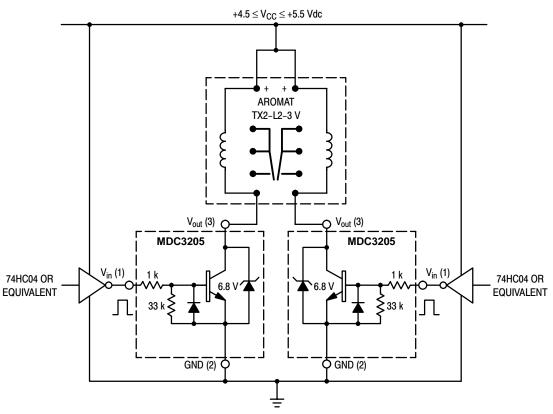


Figure 2. A 3.0–V, 200–mW Dual Coil Latching Relay Application with 5.0 V–HCMOS Interface

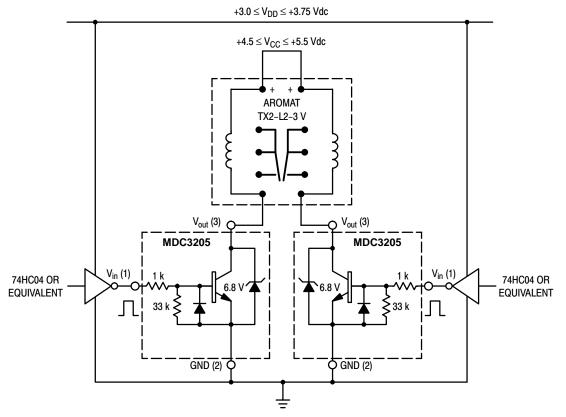
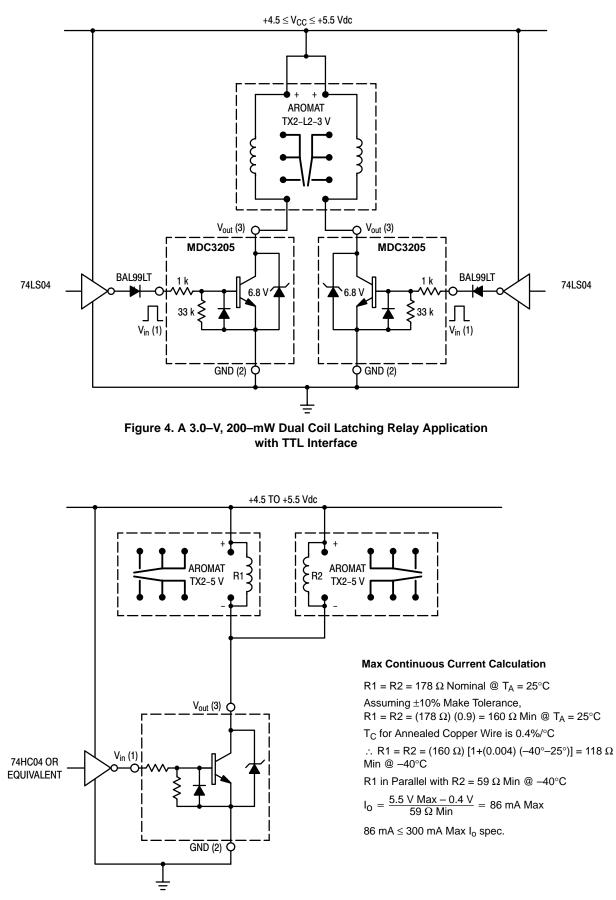


Figure 3. A 3.0–V, 200–mW Dual Coil Latching Relay Application with 3.0 V–HCMOS Interface





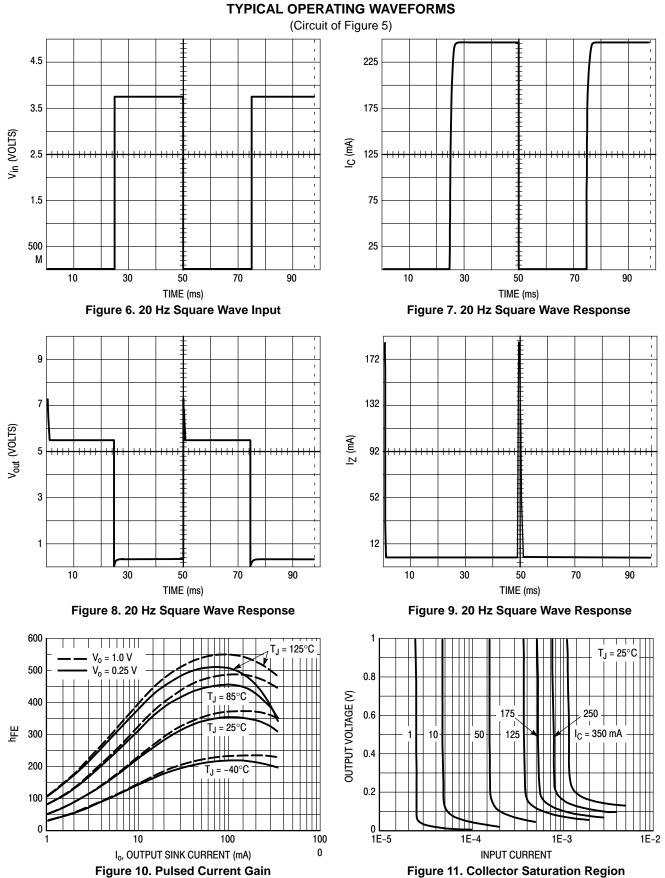
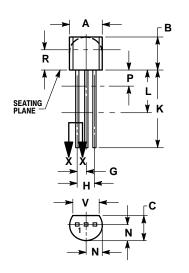
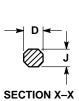


Figure 11. Collector Saturation Region

## PACKAGE DIMENSIONS

**TO-92 (TO-226)** CASE 29-11 **ISSUE AL** 





STYLE 14: PIN 1. EMITTER 2. COLLECTOR 3. BASE

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.115		2.93	
V	0.135		3.43	

# <u>Notes</u>

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